Small Signal MOSFET

20 V, 200 mA / -180 mA, Complementary, 1.0 x 1.0 mm SOT-963 Package

Features

- Complementary MOSFET Device
- 1.5 V Gate Voltage Rating
- Ultra Thin Profile (< 0.5 mm) Allows It to Fit Easily into Extremely Thin Environments such as Portable Electronics.
- These are Pb-Free Devices

Applications

- Load Switch with Level Shift
- Optimized for Power Management in Ultra Portable Equipment

MAXIMUM RATINGS (T_J = 25°C unless otherwise specified)

Para	Symbol	Value	Unit			
Drain-to-Source Voltage	V_{DSS}	20	V			
Gate-to-Source Voltag	je		V _{GS}	±8	V	
N-Channel Continuous Drain	Steady	$T_A = 25^{\circ}C$		160		
Current (Note 1)	State	$T_A = 85^{\circ}C$		115		
	t ≤ 5 s	$T_A = 25^{\circ}C$		200	mA	
P-Channel	Steady	T _A = 25°C	I _D	-140		
Continuous Drain Current (Note 1)	State	$T_A = 85^{\circ}C$		-100		
	t ≤ 5 s	$T_A = 25^{\circ}C$		-180		
Power Dissipation (Note 1)	Steady State		_	125	mW	
(14010-1)		$T_A = 25^{\circ}C$	P_{D}			
	t ≤ 5 s			200		
Pulsed Drain Current	N-Channel	t = 10 us	l	800	mΛ	
	P-Channel	t _p = 10 μs	I _{DM}	-600	mA	
Operating Junction and	T _J , T _{STG}	–55 to 150	°C			
Source Current (Body I	Is	200	mA			
Lead Temperature for S (1/8" from case for 1	T _L	260	°C			

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

- Surface-mounted on FR4 board using the minimum recommended pad size, 1 oz. Cu.
- 2. Pulse Test: pulse width \leq 300 μ s, duty cycle \leq 2%

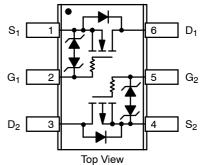


ON Semiconductor®

http://onsemi.com

V _{(BR)DSS} R _{DS(on)} Max		I _D Max
	5.0 Ω @ -4.5 V	
P-Channel -20 V	7.0 Ω @ -2.5 V	-0.18 A
	10 Ω @ -1.8 V	-0.16 A
	14 Ω @ –1.5 V	
	3.0 Ω @ 4.5 V	
N-Channel 20 V	4.0 Ω @ 2.5 V	0.00.4
	6.0 Ω @ 1.8 V	0.20 A
	10 Ω @ 1.5 V	

PINOUT: SOT-963





SOT-963 CASE 527AA



1 ---

S = Specific Device Code M = Date Code

W = Date Code

ORDERING INFORMATION

Device	Package	Shipping [†]
NTUD3127CT5G	SOT-963 (Pb-Free)	8000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Max	Unit
Junction-to-Ambient - Steady State, Minimum Pad (Note 3)	$R_{ hetaJA}$	1000	°C/W
$Junction-to-Ambient - t \le 5 s \text{ (Note 3)}$		600	

^{3.} Surface-mounted on FR4 board using the minimum recommended pad size, 1 oz. Cu.

ELECTRICAL CHARACTERISTICS (T₁ = 25°C unless otherwise specified)

Parameter	Symbol	N/P	Test Condition	on	Min	Тур	Max	Unit
OFF CHARACTERISTICS								
Drain-to-Source Breakdown Voltage	.,	N	V _{GS} = 0 V	I _D = 250 μA	20			.,
	V _{(BR)DSS}	Р		I _D = -250 μA	-20			V
Zero Gate Voltage Drain Current		N	V _{GS} = 0 V, V _{DS} = 5.0 V	T _J = 25°C			50	
				T _J = 85°C			200	nA
	I _{DSS}		., .,,,,	T _J = 25°C			-50	
		Р	$V_{GS} = 0 \text{ V}, V_{DS} = -5.0 \text{ V}$	T _J = 85°C			-200	
Zero Gate Voltage Drain Current		N	V _{GS} = 0 V, V _{DS} = 16 V	T 0500			100	
	I _{DSS}	Р	V _{GS} = 0 V, V _{DS} = -16 V	$T_J = 25^{\circ}C$			-100	nA
Gate-to-Source Leakage Current		N	., .,	.5.0.4			100	
	I _{GSS}	Р	$V_{DS} = 0 V, V_{GS} =$	±5.0 V			-100	nA
ON CHARACTERISTICS (Note 4)								
Gate Threshold Voltage	V _{GS(TH)}	N	$V_{GS} = V_{DS}$	I _D = 250 μA	0.4		1.0	V
		Р		I _D = -250 μA	-0.4		-1.0	
Drain-to-Source On Resistance		N	V _{GS} = 4.5 V, I _D = 100 mA			1.5	3.0	
		Р	$V_{GS} = -4.5V$, $I_D = -100 \text{ mA}$			4.0	5.0	Ω
		N	V _{GS} = 2.5 V, I _D = 50 mA			2.0	4.0	
		Р	$V_{GS} = -2.5V, I_D = -50 \text{ mA}$			5.0	7.0	
		N	V _{GS} = 1.8 V, I _D = 20 mA			3.0	6.0	
	R _{DS(on)}	Р	$V_{GS} = -1.8V$, $I_D = -20 \text{ mA}$			6.5	10	
		N	V _{GS} = 1.5 V, I _D = 10 mA			4.0	10	
	-	Р	$V_{GS} = -1.5 \text{ V}, I_D = -10 \text{ mA}$			7.5	14	
		N	V _{GS} = 1.2 V, I _D = 1.0 mA			5.5		
		Р	$V_{GS} = -1.2 \text{ V}, I_D = -1.0 \text{ mA}$			11.5		
Forward Transconductance	_	N	V _{DS} = 5.0 V, I _D = 125 mA			0.35		
	9FS	Р	$V_{DS} = -5.0 \text{ V}, I_D = -125 \text{ mA}$			0.26		S
CHARGES, CAPACITANCES AND GA	TE RESISTA	NCE						
Input Capacitance	C _{ISS}		N f = 1 MHz, V _{GS} = 0 V V _{DS} = 15 V			9.0		
Output Capacitance	C _{OSS}	N				3.0		1
Reverse Transfer Capacitance	C _{RSS}	1				2.2		~_
Input Capacitance	C _{ISS}					12		pF
Output Capacitance	C _{OSS}	Р	f = 1 MHz, V _{GS} = 0 V V _{DS} = -15 V			2.7		7
Reverse Transfer Capacitance	C _{RSS}					1.0		

^{4.} Switching characteristics are independent of operating junction temperatures

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Symbol	N/P	Test Condition		Min	Тур	Max	Unit
SWITCHING CHARACTERISTICS, V _{GS} = 4.5 V (Note 4)								
Turn-On Delay Time	t _{d(ON)}		V_{GS} = 4.5 V, V_{DD} = 10 V, I_{D} = 200 mA, R_{G} = 2.0 Ω			15		
Rise Time	t _r	١.,				24		
Turn-Off Delay Time	t _{d(OFF)}	N				90		
Fall Time	t _f					60		
Turn-On Delay Time	t _{d(ON)}		P $V_{GS} = -4.5 \text{ V}, V_{DD} = -15 \text{ V},$ $I_{D} = -180 \text{ mA}, R_{G} = 2.0 \Omega$			20		ns
Rise Time	t _r					37		1
Turn-Off Delay Time	t _{d(OFF)}	7 "				112		
Fall Time	t _f					97		
DRAIN-SOURCE DIODE CHARACTERISTICS								
Forward Diode Voltage	V	N				0.60	1.0	\ <i>/</i>
	V _{SD}	Р	$V_{GS} = 0 \text{ V}, I_{S} = -10 \text{ mA}$	T _J = 25°C		-0.65	-1.0	V

^{4.} Switching characteristics are independent of operating junction temperatures

TYPICAL PERFORMANCE CURVES - N-CHANNEL

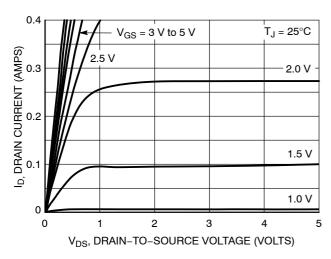


Figure 1. On-Region Characteristics

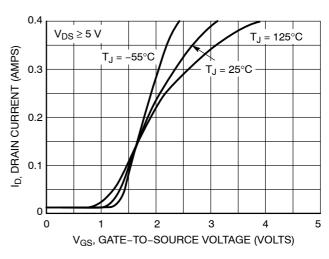


Figure 2. Transfer Characteristics

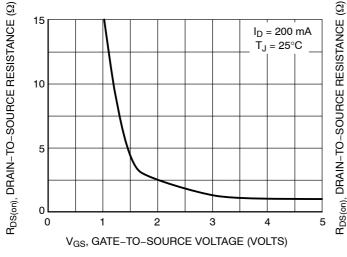


Figure 3. On-Resistance vs. Gate Voltage

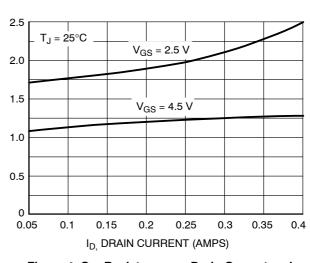


Figure 4. On-Resistance vs. Drain Current and Gate Voltage

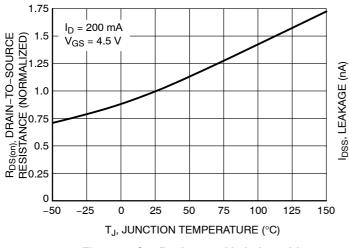


Figure 5. On–Resistance Variation with Temperature

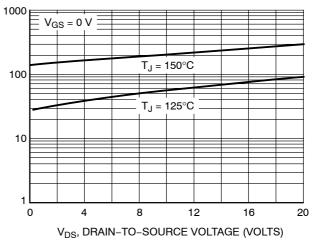


Figure 6. Drain-to-Source Leakage Current vs. Voltage

TYPICAL PERFORMANCE CURVES - N-CHANNEL

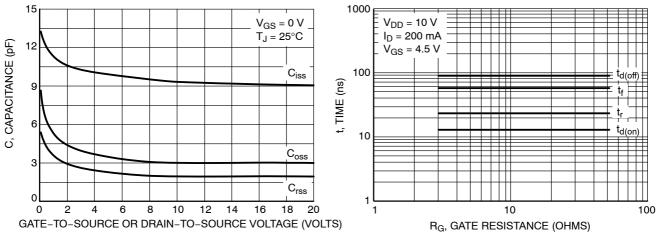


Figure 7. Capacitance Variation

Figure 8. Resistive Switching Time Variation vs. Gate Resistance

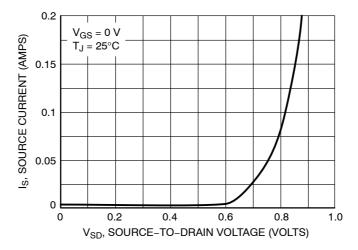


Figure 9. Diode Forward Voltage vs. Current

TYPICAL PERFORMANCE CURVES - P-CHANNEL

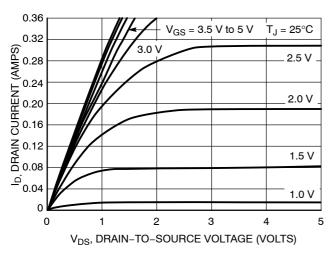


Figure 10. On-Region Characteristics

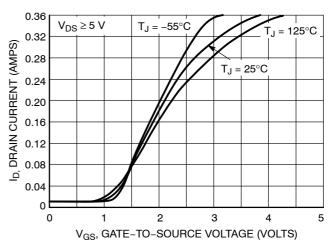


Figure 11. Transfer Characteristics

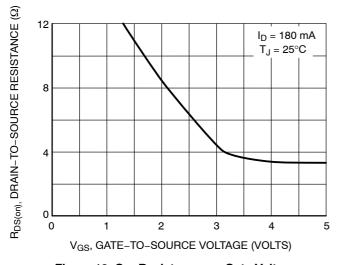


Figure 12. On-Resistance vs. Gate Voltage

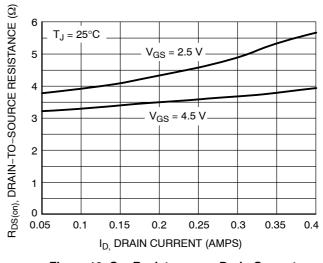


Figure 13. On-Resistance vs. Drain Current and Gate Voltage

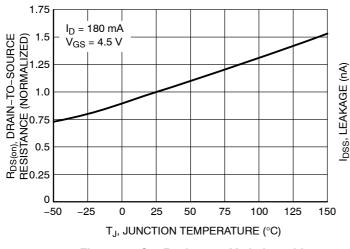


Figure 14. On–Resistance Variation with Temperature

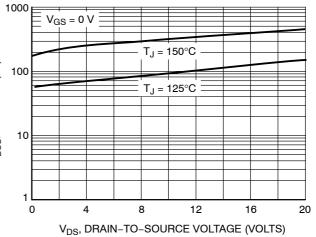


Figure 15. Drain-to-Source Leakage Current vs. Voltage

TYPICAL PERFORMANCE CURVES - P-CHANNEL

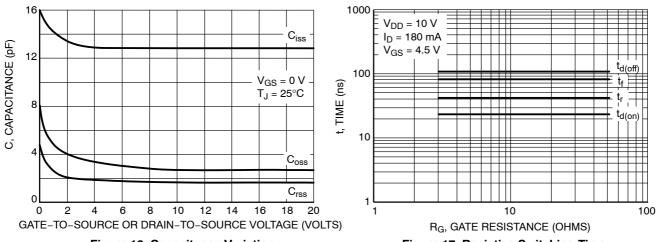


Figure 16. Capacitance Variation

Figure 17. Resistive Switching Time Variation vs. Gate Resistance

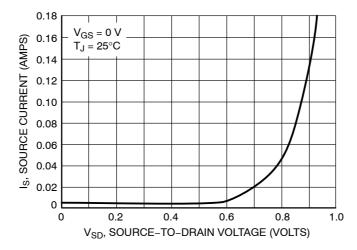
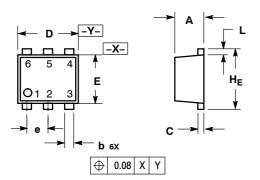


Figure 18. Diode Forward Voltage vs. Current

PACKAGE DIMENSIONS

SOT-963 CASE 527AA-01 ISSUE D

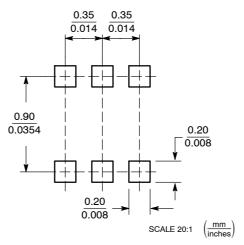


NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI
 - Y14.5M, 1982. CONTROLLING DIMENSION: MILLIMETERS
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.

	MIL	LIMETE	RS	INCHES				
DIM	MIN	NOM	MAX	MIN	MOM	MAX		
Α	0.40	0.45	0.50	0.016	0.018	0.020		
b	0.10	0.15	0.20	0.004	0.006	0.008		
С	0.05	0.10	0.15	0.002	0.004	0.006		
D	0.95	1.00	1.05	0.037	0.039	0.041		
E	0.75	0.80	0.85	0.03	0.032	0.034		
е		0.35 BS	С	(0.014 BS	C		
L	0.05	0.10	0.15	0.002	0.004	0.006		
HE	0.95	1.00	1.05	0.037	0.039	0.041		

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor and un are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice on semiconductor and are registered traderlands of semiconduction Components industries, ILC (SCILLC). SciLLC reserves are right to finate changes without further holice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifically oxyr over itime. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada

Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada

Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5773-3850

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative